

Announcement and Call for Papers

IMAPS Florida Chapters Proudly Announces



1st Southeastern Microelectronics Packaging Conference

www.imaps.org/southeast

(Co-located with the Advanced Technology Conference on Non-Hermetic Packaging Technology for Reliable Microelectronics, January 18, 2012 – www.imaps.org/hermetic)

January 17, 2012

Rosen Centre Hotel
9840 International Drive
Orlando, Florida - USA

Abstract Deadline: September 23, 2011

General Chair: Doug Bokil, Namark Process Design LLC dbokil@bokil.com	
Technical Chair: Thomas Buschor Harris Corp tbuschor@harris.com	Technical Co-Chair: Venky Sundaram Georgia Institute of Technology (PRC) vsunda@ece.gatech.edu
Chapter Organizing Committee: Mike McEntee (Florida), Tim Davis (Florida), Scott Morris (Carolinas)	

The objective of the Florida Chapter Microelectronics Symposium is to provide a forum that brings together experts from science, academia, design, manufacturing and business to discuss the latest advances and emerging applications in microelectronics and high density packaging. **Topics of interest for submission include, but are not limited to:**

• 3D Integration and Packaging	• Embedded and Integrated Actives/Passives	• Substrate Materials and Technology
• LED Packaging	• Electrostatic Discharge (ESD) Protection	• Design for Reliability / Reliability Testing
• MEMS Packaging	• Thermal Management	• Pb-Free Solder Materials, RoHS
• Photonic / Optoelectronic Packaging	• Wire Bonding & Stud Bumping	• Testing of Microelectronic Assemblies
• Sensors and Nano Packaging	• Underfill, Encapsulants and Adhesives	• Printed Electronics
• Microwave and RF Applications	• Flip Chip and Wafer Bumping Processes	• Counterfeit Electronics Detection

Those wishing to present a paper at the **Southeastern Microelectronics Packaging Conference** must submit a **250-300 word abstract electronically no later than September 23, 2011**, using the on-line submittal form at: www.imaps.org/abstracts.htm. Full written papers are not required; however, an extended abstract of 1-4 pages is due for accepted presenters no later than **December 14, 2011**. Please contact Jackki Morris-Joyner by email at jmorris@imaps.org or by phone at 202-548-4001 if you have questions. **All Speakers are required to pay a reduced registration fee and are required to attend the entire event.**

Student Competition sponsored by The Microelectronics Foundation:



The Microelectronics Foundation sponsors Student Paper Competitions in conjunction with all Advanced Technology Workshops (ATWs) and Conferences. Students submitting their work and identifying that "**Yes, I'm a full-time student**" on the abstract submission form; will automatically be considered for these competitions. The review committee will evaluate all student papers/posters and award at least one student author with a \$1,000 check. The selected student must attend the event to present his or her work and receive the award. The Foundation will return the registration fee for the winner. The winner must pay for travel and lodging expenses.

Accepted papers may be considered for publication in the *IMAPS Journal of Microelectronics and Electronic Packaging*.